

## targeted functionality

Looking to achieve high-end performance as a Tier II/Tier III OEM/CEM electronics manufacturer? Look no further than Universal Instruments' Advantis 3<sup>™</sup> Platform.

Advantis 3 provides targeted functionality for value-driven performance that is truly unmatched for the demands of cost-sensitive markets. This next-generation platform re-defines the standards of mid-tier assembly solutions with value-minded incremental capacity, easy-to-use operation, and class-leading performance.

### Scalable, incremental capacity

Advantis 3 offers incremental units of capacity with multiple head configuration options. Configure your manufacturing lines for the product you're building now and easily adapt to new products significant line or module reconfigurations. Need more output? Simply add spindles or modules for additional throughput or feeder capacity.

- Minimal entry price, lower initial investment costs
- Targeted functionality buy only what you need and upgrade later
- True flexibility Easily reconifigured for changing requirements
- Investment protection class-leading technologies for long usable life
- Lowest cost-of-ownership robust technologies with minimal maintenance
- Scalable capacity double CPH without changing heads or adding beams



## get a quality product to market fast!

Universal Instruments delivers complete factory-wide process, manufacturing and support solutions from product concept throughout the entire product lifecycle. A technology partnership with Universal Instruments ensures you get a quality product to market quickly and efficiently.



### Class-leading Performance

you're prepared for your next product, no matter how complex.

- Finest Pick PPM and final product yield
- industry's fastest tact time
- component type

Advantis 3 has raised our expectations of a midrange platform. enabling us to quote any job at any time.



- Advantis 3 is powered by the most advanced technologies of any mid-tier assembly solution. These valuable tools will both energize and refine your manufacturing process. You'll be confident that
- Superior line balancing with no reconfiguring
- Patented VRM linear motor technology with closed-loop, direct drive positioning
- Patented Lightning head technology with 01005 30mm square component range and the

• Patented Magellan® digital optics providing both wide field-of-view and high resolution on every

Intelligent impact sensing, Auto XY pick update, and Auto Z update at pick and place

## Flexible, scalable solutions for maximum versatility

Advantis 3 Platform solutions address any market segment with flexible line configurations built on a flexible platform foundation. Advantis 3 provides investment protection with the ability to efficiently change and grow to conquer current and future challenges.

### Change the program, not the line

Advantis 3 solutions give you the flexibility to configure exactly the right line for your specific business requirements. An unrivaled component range ensures outstanding performance, even with a significant change in customer portfolio. Advantis lines don't require hardware reconfiguration to deal with new products, simply change the program and get back to highperformance production.



 Chip 6 30 × ( • MELF Tant Cap **Head** (30 × SOIC InLine 7 Head (150mm) TSOP • DPAK Lightning • QFP • BGA PLCC • CSP Electrolytic Cap Connectors • CCGA Odd Form



Lightning Head - Speed without Compromise Lightning takes the guess work out of configuring your factory for maximum flexibility and productivity. Lightning delivers the industry's fastest tact rate and an 01005 - 30mm square component range that is without comparison, allowing you to be proactive with the next product you're asked to build.



InLine7 Head - The all-around performer The Advantis component range doesn't stop at Lightning's 30mm square maximum. The InLine7 Head guickly and accurately places components as small as 0201 up to 55mm square and 25mm tall with single field-of-view inspection. Gang pick up to seven components.

# **Targeted solutions** for a **range** of applications

As a Tier II/Tier III or Consumer electronics manufacturer, you need a solution that is tailored to your production requirements with the ability to adapt within them. The Advantis 3 portfolio enables you to configure your lines to accel with the products you run and the way you run them.

### Market challenges

- · Adapt to every product
- · Lowest capital investment
- Investment protection future-proof machine
- Incremental capacity requirements
- Place all component types
- High Utilization











### Advantis 3 solves your challenges

- Monitor, diagnose, and auto-recover
- Fast NPI and product ramp up
- Scale on demand
- Excellent line balancing
- Superior odd-form capabilities
- Best first-pass yield

### Advantis 3 AC-90T

Advantis 3 (triple-beam)

An ultra-high-speed small part placer delivering high-end performance for cost-sensitive markets

- Triple-beam, dual-drive overhead gantry system
- Three 30-spindle rotary Lightning placement heads
- On-the-head vision system



# Advantis 3 AC-15S

Advantis 3 (single-beam)

A scalable mid-speed solution for mediumvolume environments. Upgradeable to AC-30S.

- Single-beam, dual-drive overhead gantry system
- One 15-spindle rotary Lightning placement head,
- upgradeable to 30 spindles • On-the-head vision system

### Advantis 3 AC-30S

Advantis 3 (single-beam)

#### A flexible line booster solution or high-speed small part placer

- Single-beam, dual-drive overhead gantry system
- One 30-spindle rotary Lightning placement head
- On-the-head vision system





### Advantis 3 AI-07S

Advantis 3 (single-beam)

A flexible single-machine solution or end-of-line multifunction/odd-form placer with mid-speed performance

- Single-beam, dual-drive overhead gantry system
- One 7-spindle Inline7 placement head
- Upward-looking vision system

| SPECIFICATIONS                      |                       | AC-90T  | AC-30S                           | AC-15S                           | AI-07S                           |
|-------------------------------------|-----------------------|---|----------------------------------|----------------------------------|----------------------------------|
| Placement Rate (cph (sec per comp)) | Max                   | 102,500 (0.035)                               | 34,500 (0.104)                   | 16,000 (0.225)                   | 15,300 (0.235)                   |
|                                     | 1-Bd IPC              | 60,000 (0.060)                                | 22,600 (0.159)                   | 13,200 (0.273)                   | 11,400 (0.316)                   |
| Accuracy (μm@1.33 Cpk/1.00 Cpk)     | Chips                 | ±60 / ±45                                     |                                  |                                  |                                  |
|                                     | ICs                   | ±60 / ±45                                     |                                  |                                  | ±45 / ±34                        |
| PCB Dimensions (mm("))              | Max (WxLxH)           | 457 x 635 (18 x 25)                           | 457 x 635 <sup>2</sup> (18 x 25) | 457 x 635 <sup>2</sup> (18 x 25) | 457 x 635 <sup>2</sup> (18 x 25) |
|                                     | Min (WxLxH)           | 50.8 × 50.8 × 0.508 (2 × 2 × 0.02)            |                                  |                                  |                                  |
|                                     | Max Weight (kg (lbs)) | 2.72 (6.0)                                    |                                  |                                  |                                  |
| Component Range (mm ("))            | Max (WxLxH)           | 30 x 30 x 6 <sup>1</sup> (1.18 x 1.18 x 0.24) |                                  |                                  | 150 x 150 x 25                   |
|                                     |                       |   |                                  |                                  | (5.90 x 5.90 x 0.98)             |
|                                     | Min (WxLxH)           | 0.18 × 0.38 × 0.10 (0.007 × 0.015 × 0.004)    |                                  |                                  | 0.25 x 0.5 x 0.15                |
|                                     |                       |   |                                  |                                  | (0.01 x 0.02 x 0.006)            |
| Machine Dimensions (mm("))          | (LxDxH)               | 2372 x 2160 x 1930                            | 1676 x 2248 x 1930               | 1676 x 2248 x 1930               | 1676 x 2248 x 1930               |
|                                     |                       | (93.4 x 85.0 x 75.9)                          | (66 x 88.5 x 75.9)               | (66 x 88.5 x 75.9)               |                                  |
| Machine Weight (kg/lbs)             |                       | 3500 (7700)                                   | 3250 (7150)                      | 3250 (7150)                      |                                  |
| Feeder Types                        |                       | tape, stackable matrix tray                   |                                  |                                  |                                  |
|                                     |                       | 16 1 1  |                                  |                                  |                                  |

<sup>1</sup> 6mm nozzles required <sup>2</sup> Optional Long Board Kit required





## **Innovative technologies...**

Universal Instruments' platform solutions feature innovative technologies for every step of your manufacturing process. AdVantis 3 takes advantage of best-in-class technologies and comprehensive software solutions work together to ensure maximum efficiency and productivity.





- High-accuracy (1µm) closed-loop positioning control supports current, converging and emerging technologies
- High acceleration up to 2.5G
- Dual-drive architecture reduces settle times
- Thermally stable, non-magnetic
- Direct drive technology stands the test of time to maintain its accuracy indefinitely
- Self-correcting dual-drive control





#### Lightning Placement Head

- The industry's fastest placement head 55ms duty cycle
- Single pick point eliminates gang-picking concerns and speed derates associated with in-line heads
- Dual on-the-head cameras 0.8 and 2.6 mil/pix for 01005 30 x 30mm vision capability – chips, BGA/CSP, Melf, QFP, connectors, up to 6mm tall, on the same head
- 30 spindles amortizes travel time over more components
- · Spindles incorporate high-accuracy theta drive



Incorrect feeder pitch/width



- Exceptional flexibility for NPI through high-volume, high-throughput applications
- High resolution of 1024 x 1024 to facilitate small part feature recognition
- Large 55mm field-of-view minimizes multiple scans of large bumped/leaded devices
- Provides substantial throughput improvements for applications that typically require multiple FOVs
- Lighting calibration is performed on the machine, eliminating machine-to-machine lighting intensity variation
- UPS+ Platform Software monitor, diagnose, and auto-recover
- Auto-spindle bypass: Independent, intelligent spindles are automatically bypassed when thresholds are exceeded and product continues to run
- Incorrect feeder pitch/width: Verifies correct settings
- Incorrect nozzle: Identifies and locates incorrect nozzles
- Feeder error recovery: Displays location of exhausted feeder and designates whether validation is required
- Incorrect component: Identifies and locates incorrect components
- · Board transfer: Graphically displays where in the platform or conveyor the error occurred and provides instructions to resolve the issue

e wrong nozzle is mounted. e nozzle is missing. e nozzle definition or lighting values may be incorrect.

Incorrect nozzle







warranty

### **Base Frame** Precision machined to within 1um from corner to

corner for extreme accuracy Backed by an industry-best



- Both 0.55 and 2.8 mil/pix cameras for 01005 - 30 x 30mm vision capability Chips, BGA/CSP, Melf,
- QFP, connectors, up to 6mm tall, on the same head

#### Quick and Easy Calibration

- Disconnect spindles/ calibrate in < five minutes Automatic nozzle centering.
- accuracy assured at



#### Nozzle auto-calibration

Automatic Pick Update



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- Automatically tunes feeder pick point based on vision results for optimal small part pick performance APU is enabled for all feeders



#### changeovers in minutes Removable feeder bank kit transforms feeder banks into removable banks











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## ... for **every step** of your manufacturing process

#### Large Board Size Capability

• Up to W457mm x L635mm (18" x 25") to address any market or end product Board support for maximum yield under all circumstances

#### Intelligent Lightning Spindles

 Fast and accurate directdrive theta

Vacuum generated at spindle - fast reaction / low maint Self-ID intelligence Dry spindle bearing/no oil

• Automatic spindle bypass

#### NPI Software

 Scrap-free first article build · Verifies the complete production process: board. feeders, fiducials,

components, pre/post-place x. y and theta data

#### Touchdown Sense / Auto Z

Compensates for varying nick heights

Guarantees ideal placement force

 Improves throughput, pick ppm and yield, reduces scrap and nozzle wear

#### Feeder Storage Cart

 Provides storage for tape. track and/or trav feeders in one convenient location Each cart holds up to 132 8mm single-lane feeders

#### Feeder Setup and Calibration Cart

Uses a precision system to accurately align feeder pockets to the machine's pick point

#### Tape Scrap Bin

A low-cost means of keeping the production floor clean by collecting the scrap tape















#### InLine7 Placement Head

- Provides high-speed IC and chip placement capability
- Gang pick up to 7 components
- Picks from trays, tape, tube and odd-form feeders

#### Single Pick Point

- Eliminates gang-picking concerns over variations among multiple feeders and packages
- 30 online spindles provide amortized travel time over more components

#### Real Closed-Loop Control

- X, Y and Z linear encoder feedback during pick/place
- Auto pick/Auto Z update automatically compensate for packaging variations
- 1 um encoders for superior accuracy and repeatability

#### Auto Setup Validation

- Closed-loop validation of feeder locations during setup and changeover
- Provides security by stopping production until correct part is scanned

#### Feeder Setup Cart

- Provides power and air for offline feeder setup/reload
- Cart design for easy mobility

#### **Tape Cutter**

- Automatically cuts off small pieces of reel tape and collects them in a bin for ease of disposal
- Accommodates two banks of feeders

#### Nozzle Changer

Large online capacity of up to 140 inputs

## Versatile **component** feeding solutions

Universal offers the fullest complement of input types in the industry; from strip tape NPI and tube feeders to high-volume continuous-splice tape feeders, random access matrix tray feeding and oddform feeders to support any manufacturing challenge.

#### **Tape Feeders**



#### High-performance Gold Plus

A family of featureloaded, high-speed. continuous-splice tape feeders

#### High-performance Gold Plus

- Single-lane
- 71 msec index speed (4mm index)
- 8-88mm tape widths, multi-pitch
- Allows up to 72 inputs/machine
- 0201-gualified no need for dedicated 0201 feeders
- Continuous splice capability
- Precision locating features (8/12mm) for improved chip delivery performance
- Unique feeder ID and reel detection sensor, compatible with PSV
- Standard High Torque Mode for all 16 88mm
- Available 7" or 13" inch reel holder options
- Two-year warranty

#### High-performance Gold Plus 60

- Dual-lane
- 60 msec index speed (4mm index)
- 8mm tape width, multi-pitch
- Allows up to 144 inputs/machine

#### **Tube Feeders**

#### Tube Feeder

- Multiple-input track feeder
- Supports and positions component tubes for component transport to the pick position

#### Multi-Tube Feeder

- Single-input feeder Automatically ejects empty
- tubes while continuing to pick components Can be manually loaded with
- full tubes during operation

#### **Tray Feeders**



Direct Tray Feeder (DTF) A random access matrix tray feeder for use when the demands are beyond that of a Stationary or Stackable Matrix Tray Feeder.

Single-tray single-part

number tray feeder

trays for pickup

• Supports and secures the

Tray height is adjustable to

compensate for variation • Available in three sizes

- Handle up to 40 JEDEC and non-standard vacuum formed matrix trays
- Operate in 3 modes: Exchange, Concurrent and Job
- Supports Platform Setup validation
- Reduce overall floor space requirements
- Experience no downtime associated with tray replenishment
- · Ability to mount two units per platform

#### Strip Matrix Tray Feeder Stationary Matrix Tray Feeder

- Ideal for NPI solutions
- Holds up to 5 strips • Applicable for multiple strip
- components



#### Special Feeders

for components utilizing bowl, GPAX and other feeding

devices

#### short strips of 8/12mm tape Available in stationary matrix trav form with up to 10 inputs or in single-part number input

Strip Tape Feeders

Ideal for NPI or low-volume

Delivers components from

# **Equipped** to **excel** with intelligent software

Universal Instruments' Dimensions Software Suite features powerful NPI solutions to accelerate entry of your products into production, and turnkey line management tools that connect Advantis 3 into your overall manufacturing operation.

#### **NPI** Software

Fast, efficient introduction of new products into full production determines success with today's small batch sizes. Use the Dimensions suite of NPI software tools to easily import and verify design data, balance your lines, generate optimized programs, and create grouped feeder setups for minimized



leverage Advantis' machinefine-tune your processes.

#### Dimensions Programming & Optimization Machine-Side NPI Part Data Management Feeder Inspection Line Balancing Transfer Board Optimization **Fiducial Inspection** Grouping **Pre-Placement Inspection** changeover time. You can also Family Group Setups **Circuit/Offset Inspection** Populate Board Offline Component Scan side NPI tools at the line to Post-Placement Inspection · Import any kind of design data Generate balanced and optimized products Run Full Produ Create grouped setups to minimize changeover • Debug process problems online Achieve a production-ready first pass yield **Dimensions Shop Floor Control Software** Dimensions shop floor control software helps you get more from your Advantis 3 investment. Gain visibility into your lines with Linechart, and use Line Manager to maximize your utilization and track and trace materials during production. Company Network Dimensions Offline Setup Offline changeover Linechart Reel quantity management • Feeder maintenance Line-level reports Feeder & component tracking Real-time production data Key performance indicators Line Manager Automatic setup validation 'Feeder Low' warnings Consumption tracking Flexible setup Work order support



Odd Form Feeders • A variety of solutions

